

inTEST to Participate in the 10th Annual CEO Investor Summit 2018

July 2, 2018

Accredited investor and publishing research analyst event to be held concurrently with SEMICON West and Intersolar 2018 in San Francisco

MOUNT LAUREL, N.J., July 02, 2018 (GLOBE NEWSWIRE) -- inTEST Corporation (NYSE American:INTT), an independent designer, manufacturer and marketer of thermal management products and semiconductor automatic test equipment (ATE) interface solutions, is pleased to announce the Company will participate in the 10th Annual CEO Investor Summit, taking place Wednesday. July 11th, 2018 in San Francisco. California.

James Pelrin, President & CEO, and Hugh Regan, Jr., Chief Financial Officer, will be participating on behalf of the Company. The presentation materials utilized during the conference will be available on the investor relations section of inTEST's website at www.intest.com.

10th Annual CEO Summit/ July 11, 2018 / San Francisco, CA

The CEO Summit is an accredited investor and publishing research analyst event held concurrently with SEMICON West and Intersolar 2018 in San Francisco. The event is hosted by executive management from participating companies and will feature a "round-robin" format consisting of small group meetings, each 30 minutes in duration. During the event, investors and analysts will have the opportunity to meet with up to 10 of the 21 management teams during the 30-minute group meeting sessions, as well as opportunities to meet with additional management teams during the breakfast, a lunch networking session, and the concluding reception.

The 21 management teams collectively hosting the 2018 CEO Summit include: ACM Research (ACMR), Advanced Energy Industries (AEIS), Aehr Test (AEHR), Axcelis (ACLS), BE Semiconductor Industries (BESI.AS), Brooks (BRKS), Cabot Micro (CCMP), Camtek (CAMT), Cohu (COHU), CyberOptics (CYBE), Electro Scientific (ESIO), FormFactor (FORM), Ichor Systems (ICHR), Intermolecular (IMI), inTEST (INTT), Intevac (IVAC), Kulicke & Soffa (KLIC), Nanometrics (NANO), Photon Control (PHO.TO), Rudolph (RTEC), and Soitec (SOIT). Cowen & Co. is sponsoring the networking luncheon and Jefferies is sponsoring the closing cocktail reception.

The CEO Investor Summit is by invitation only and is open to accredited investors and publishing research analysts. As space is limited, please RSVP early. Hosts reserve the right to limit attendance as necessary. Last day for registration is July 6, 2018.

While held concurrently with SEMICON West and Intersolar 2018, the event is not affiliated with the show.

RSVP Contacts for 10th Annual CEO Summit 2018

To RSVP for the CEO Summit, please contact either of the Summit's co-chairs.

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About inTEST Corporation

inTEST Corporation designs and manufactures engineered solutions for ATE and other electronic test, as well as industrial process applications. Our products are used by semiconductor manufacturers to perform development, qualifying and final testing of integrated circuits (ICs) and wafers, and for other electronic test across a range of industries including the automotive, defense/aerospace, energy, industrial and telecommunications markets. We offer induction heating products for joining and forming metals in a variety of industrial markets, including automotive, aerospace, machinery, wire & fasteners, medical, semiconductor, food & beverage, and packaging. Specific products include temperature management systems, induction heating products, manipulator and docking hardware products, and customized interface solutions. We have established strong relationships with our customers globally, which we support through a network of local offices. For more information visit www.intest.com.

Contacts

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